

ADOPTION NOTICE

ASTM F459, "Standard Test Methods for Measuring Pull Strength of Microelectronic Wire Bonds" was adopted on 30 October 2000 for use by the Department of Defense (DoD). Proposed changes by DoD activities must be submitted to the DoD Adopting Activity: Defense Supply Center, Columbus, Attn: DSCC-VAS, 3990 E. Broad St., Columbus, OH 43216-5000. . Copies of this standard may be obtained from the American Society for Testing and Materials, 100 Barr Harbor Drive, West Conshohocken, PA 19428-2959.

Custodians:

Army - CR
Navy- EC
Air Force - 11
NASA- NA
DLA - CC

Adopting Activity:
DLA - CC

Review Activities:

Army - AR,MI,SM
Navy - OS, SH, TD, AS, CG, MC
Air Force - 19, 99

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